



Jens Kirkegaard
DANSK VANDBYGNINGSTEKNISK SELSKAB

DANISH SOCIETY OF HYDRAULIC ENGINEERING

v/ H. F. Burcharth, AUC, Sohngårdsholmsvej 57, 9000 Aalborg. Tlf. 08 - 142333
Denmark

15 January 1988

HG/isc/09-OD11

SEMINAR ON RECENT DEVELOPMENT WITHIN OFFSHORE DESIGN AND SYSTEMS

Time : Thursday, 11 February 13.00-21.00 hrs.

Place : Statens Byggeforsknings Institut (SBI) and
Danish Hydraulic Institute

PROGRAMME

- 13.00-13.45 Visit to Tecnomare's Tripod Model at
Danish Hydraulic Institute
Agern Alle 5
(at the offshore basin)
- 14.00-14.15 Welcome to the seminar at
Statens Byggeforsknings Institut (SBI)
Dr. Neergaardsvej 15
2970 Hørsholm
- 14.15-14.45 1. Drift Forces and Damping of Floating Structures
by S.E. Sand, DANOP, and Christian Aage, ISH
- 14.45-15.15 2. Freak Waves and Freak Wave Groups
by P. Klinting, V. Jacobsen, and H. Gravesen, DHI
- 15.15-15.45 Coffee Break
- 15.45-16.15 3. Shielding
by N.-E. Ottensen Hansen, LIC Engineering
- 16.15-16.45 4. Status Numerical Modelling of Floating Structures
by P.A. Madsen, DHI, and J. B. Christoffersen, SL
- 16.45-17.00 Break

- 17.00-17.30 5. Status and Trends for Floating Structures
by H. Sannum, Aker Engineering
(subject to confirmation)
- 17.30-18.00 6. Jack-up used for Production Platforms on Marginal
Fields
by S.E. Sand, DANOP
- 18.00-19.00 Dinner
- 19.00-19.30 7. The Tripod Project
by Mr. G. Busetto, Tecnomare
- 19.30-20.00 8. Arctic Platforms
by K. B. Olesen, R&H
- 20.00-20.45 9. Discussion about Possible Danish Interest in
Floating Production

Members of Danish Society of Naval Architecture and Marine
Engineering and the Hydrocarbon Committee under the Danish
Society of Civil Engineers are invited to join the seminar.

Enrollment is done by paying DKK 400 to giro 319 52 52

Danish Society of Hydraulic Engineers

P.O. Box 190

9900 Frederikshavn

Telephone: (08) 422477

no later than 4 February 1988.

Best regards

for Danish Society of Hydraulic Engineers



Helge Gravesen

Secretary

(Telephone: 02-868033)

DANOP. 10000 +
20000

V-MG.

SILVER. OKTOBER.

Bond ordentl.

30 etc.

rig pi plads. 20.